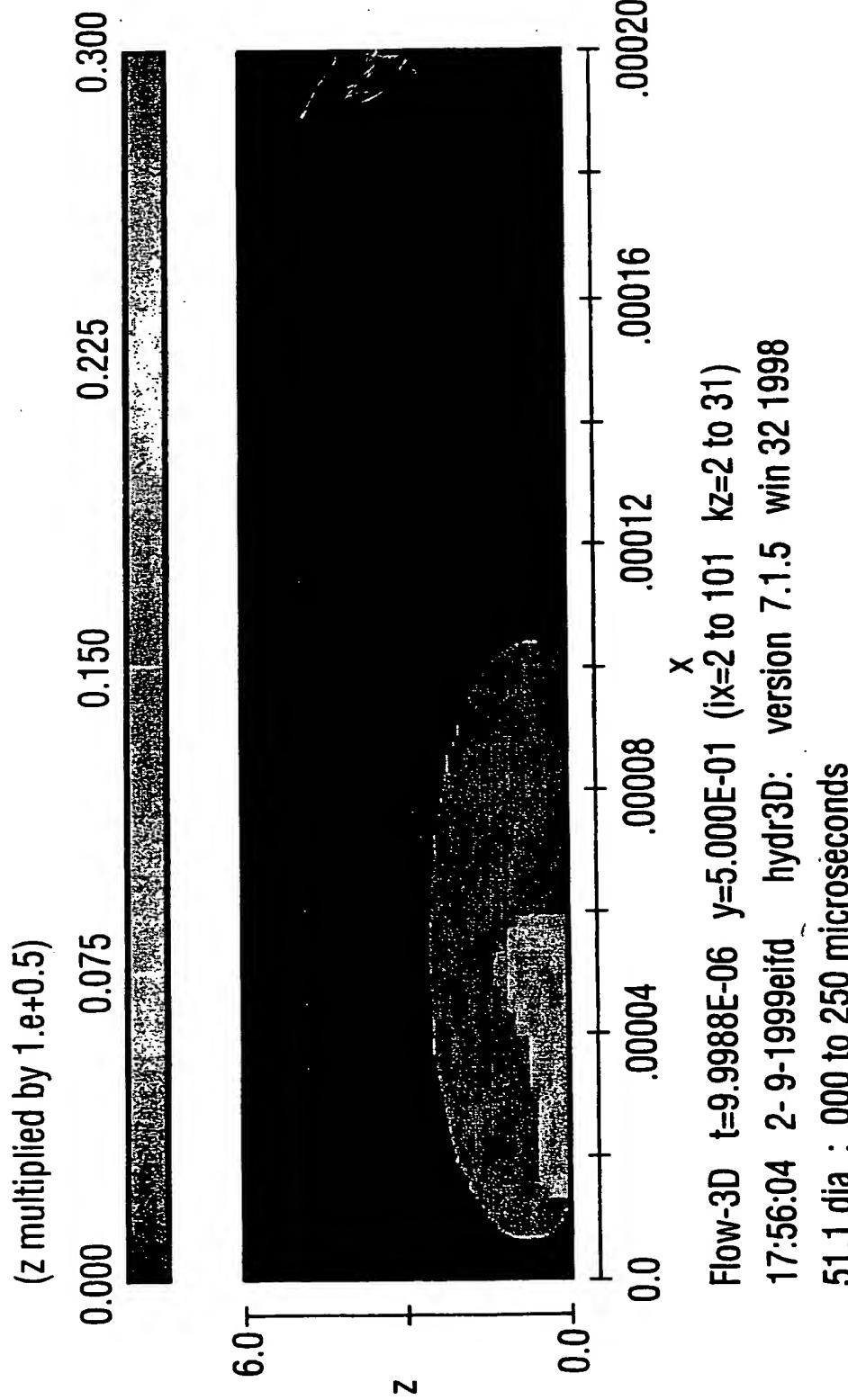


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FIG. 1

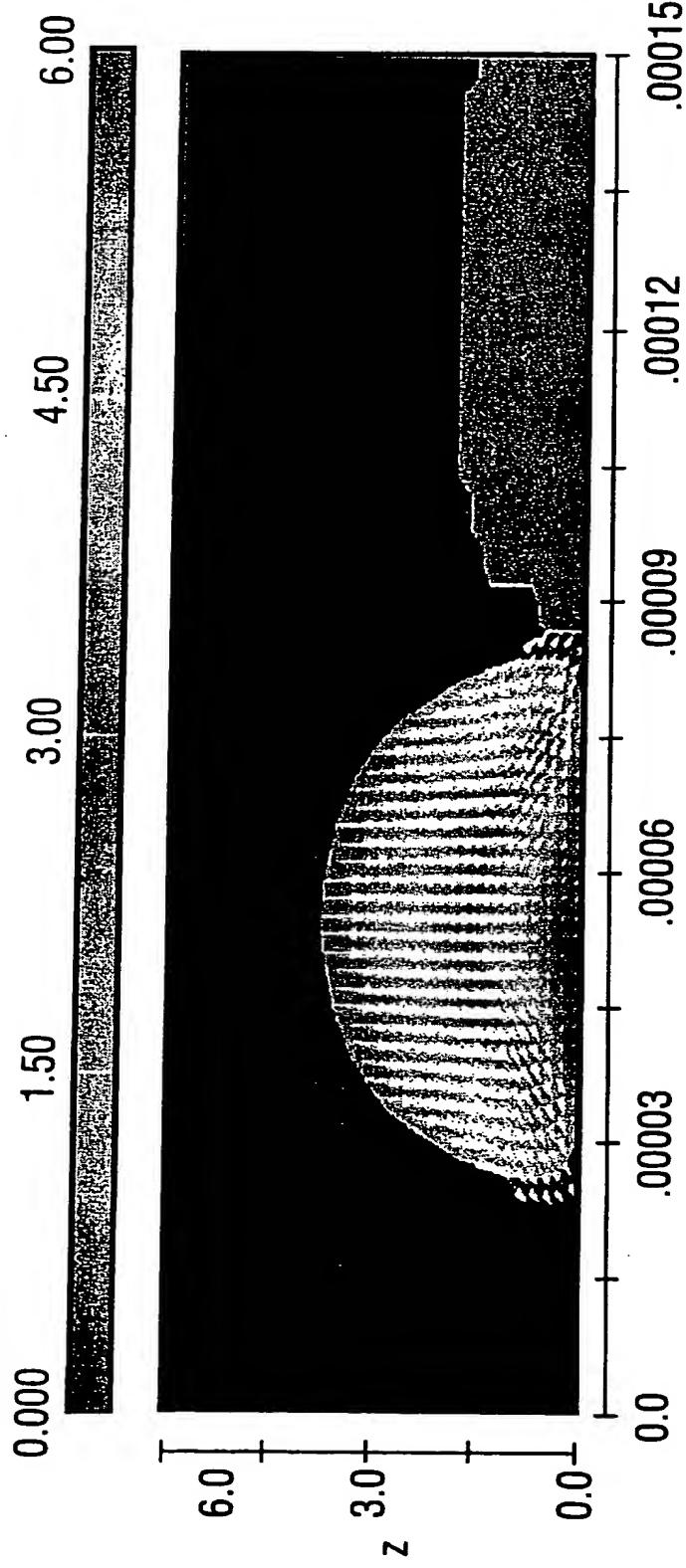
Velocity magnitude contours



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FIG. 2a

Velocity 250 to 263 microseconds (vmax=5.50E+00)
(z multiplied by 1.e+0.5)



Flow-3D t=3.0000E-06 y=1.000E-06 (ix=2 to 76 kz=2 to 31)
17:30:04 2- 17-1999eifd hydr3D: version 7.1.5 win 32 1998
51.1 dia : Fluid droplet impact with solidified droplet 3D

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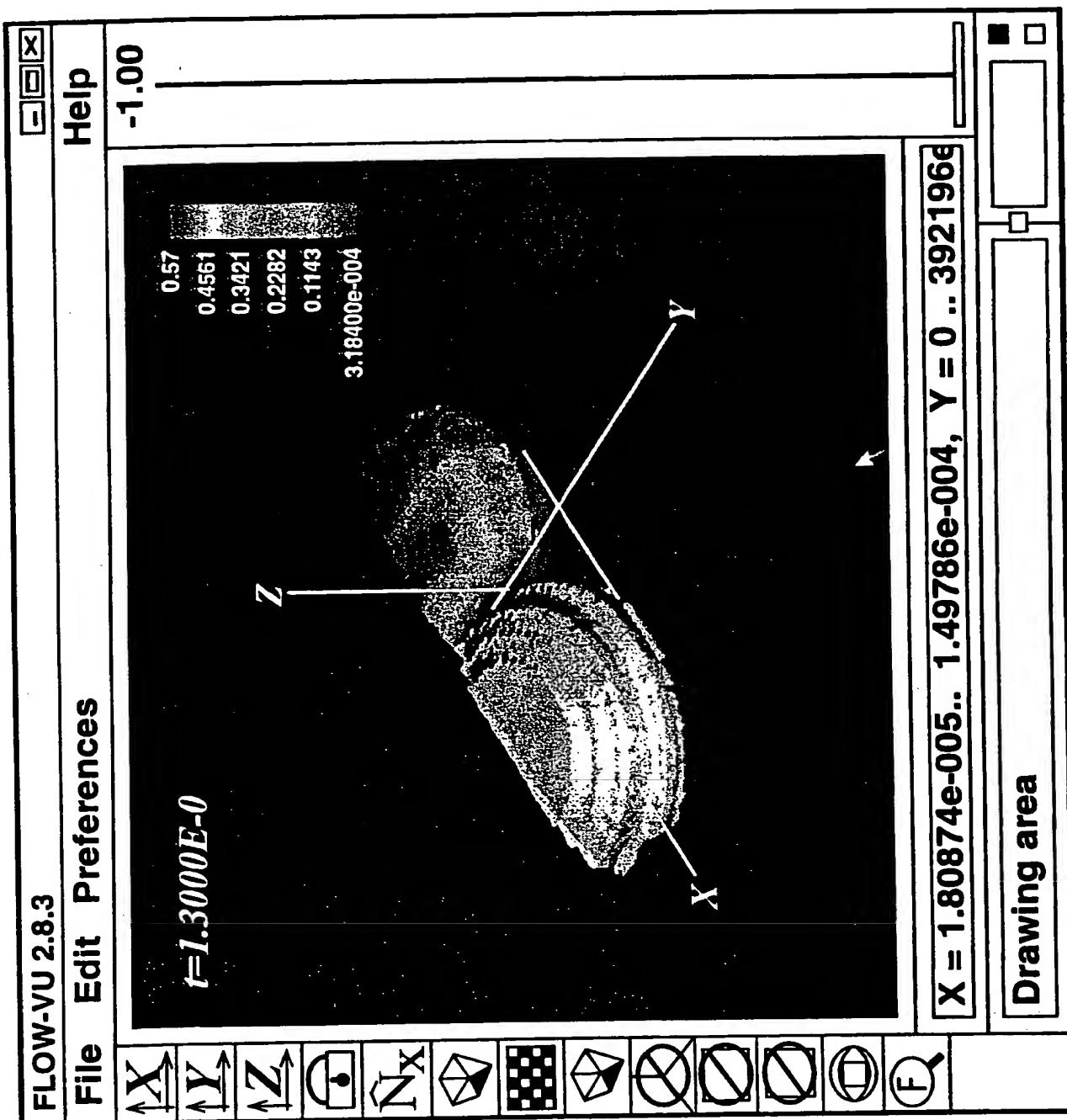


FIG. 2b

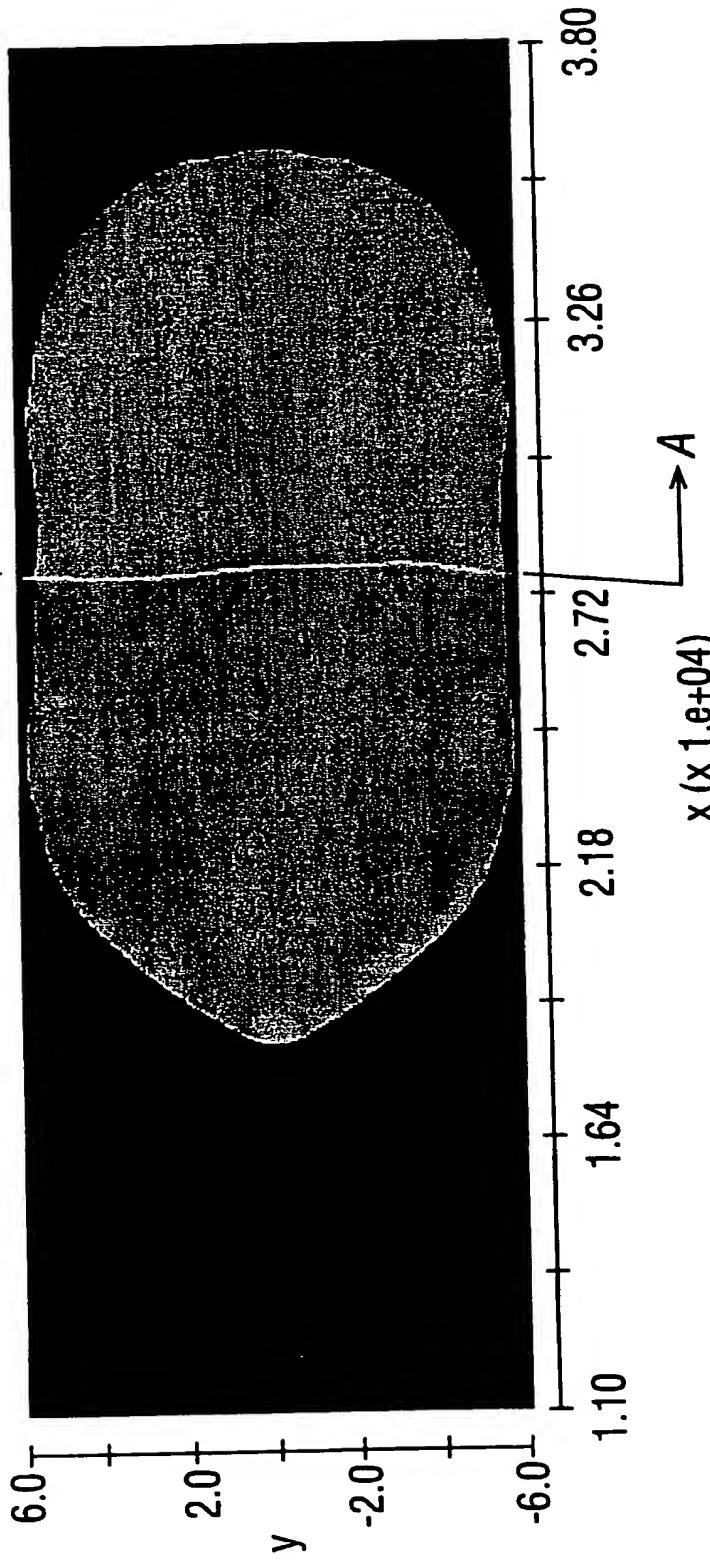
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FIG. 3

Section A-A
 Plan of droplet substrate boundary at t=930 microseconds

(y multiplied by 1.e+0.5)

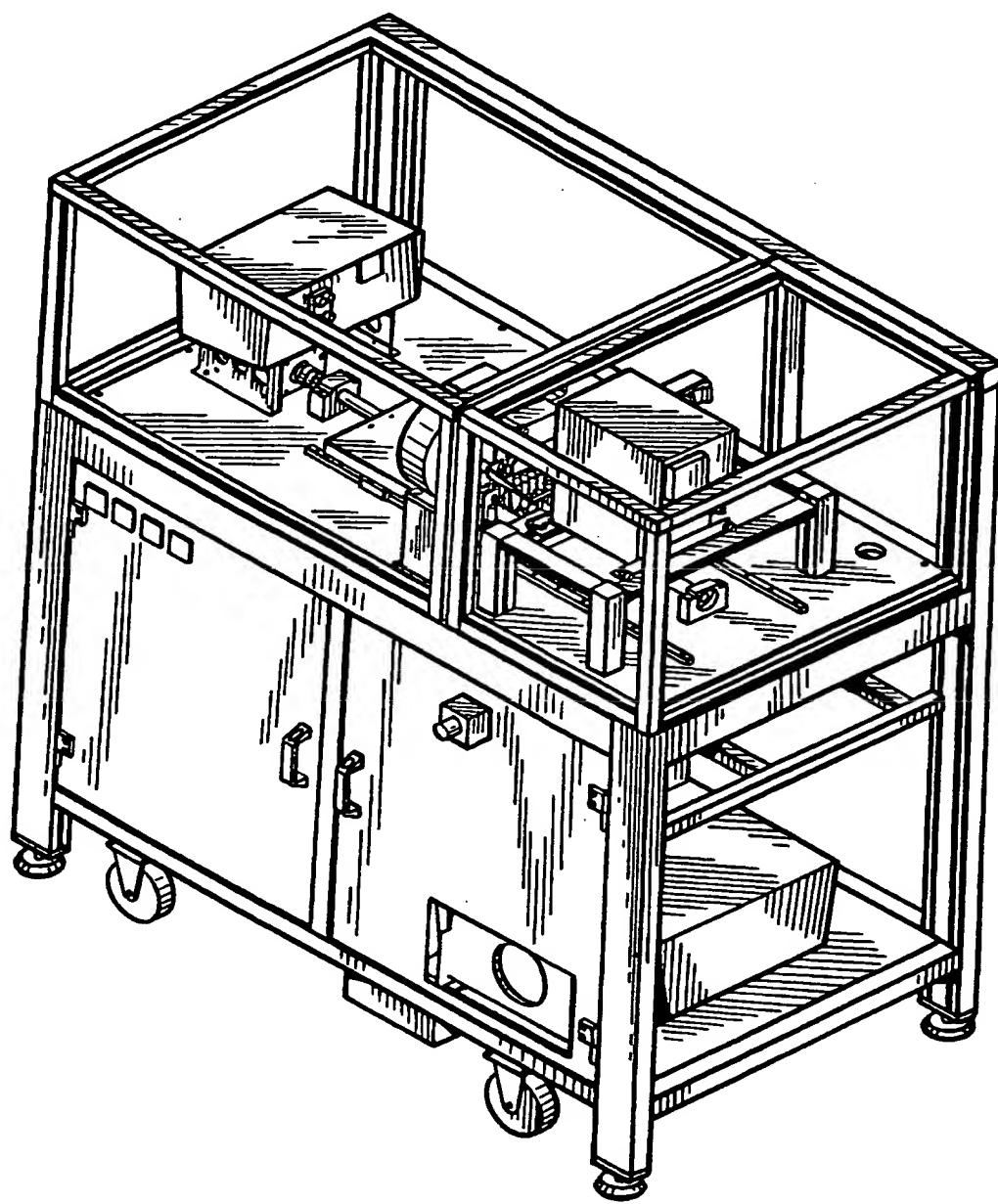
0.000	0.075	0.150	0.225	0.300
-------	-------	-------	-------	-------



Flow-3D t=6.809E-04 z=1.000E-06 (ix=2 to 136 iy=2 to 31)
 20:04:05 2-17-1999eitd hydr3D: version 7.1.5 win 32 1998
 51.1 dia : 675 to 975 microseconds - 3D droplets

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FIG. 4



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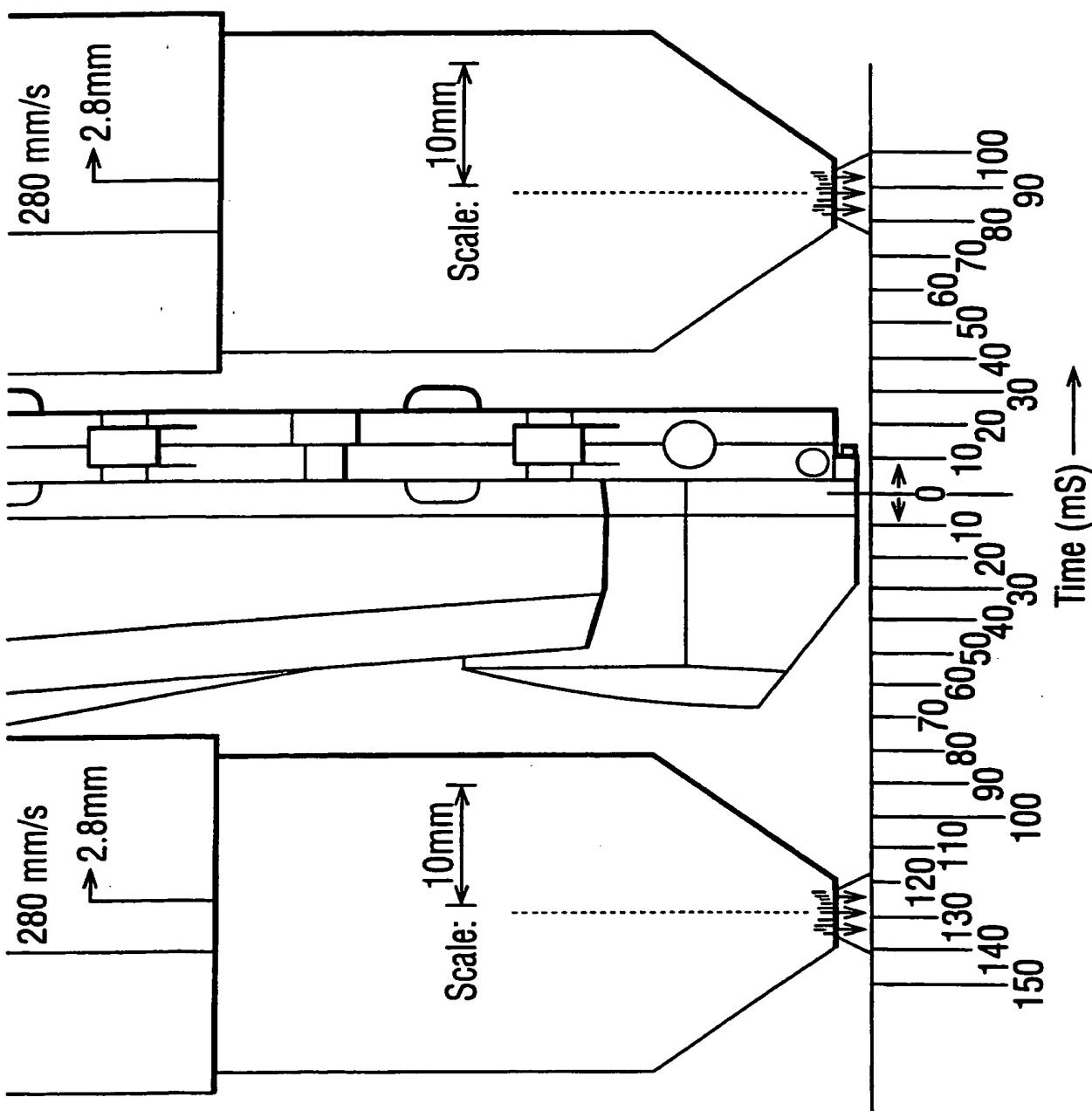
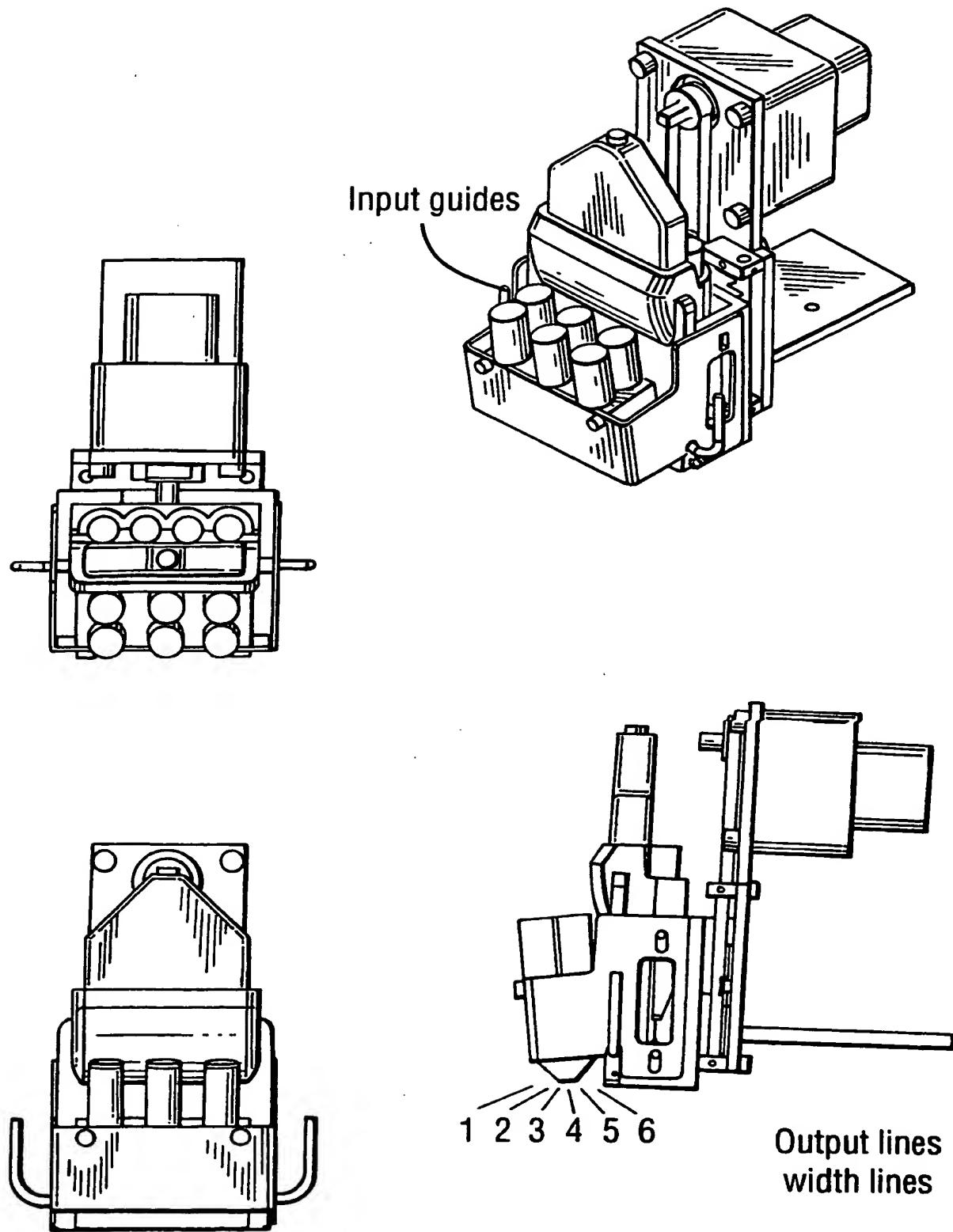


FIG. 5a

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FIG. 5b



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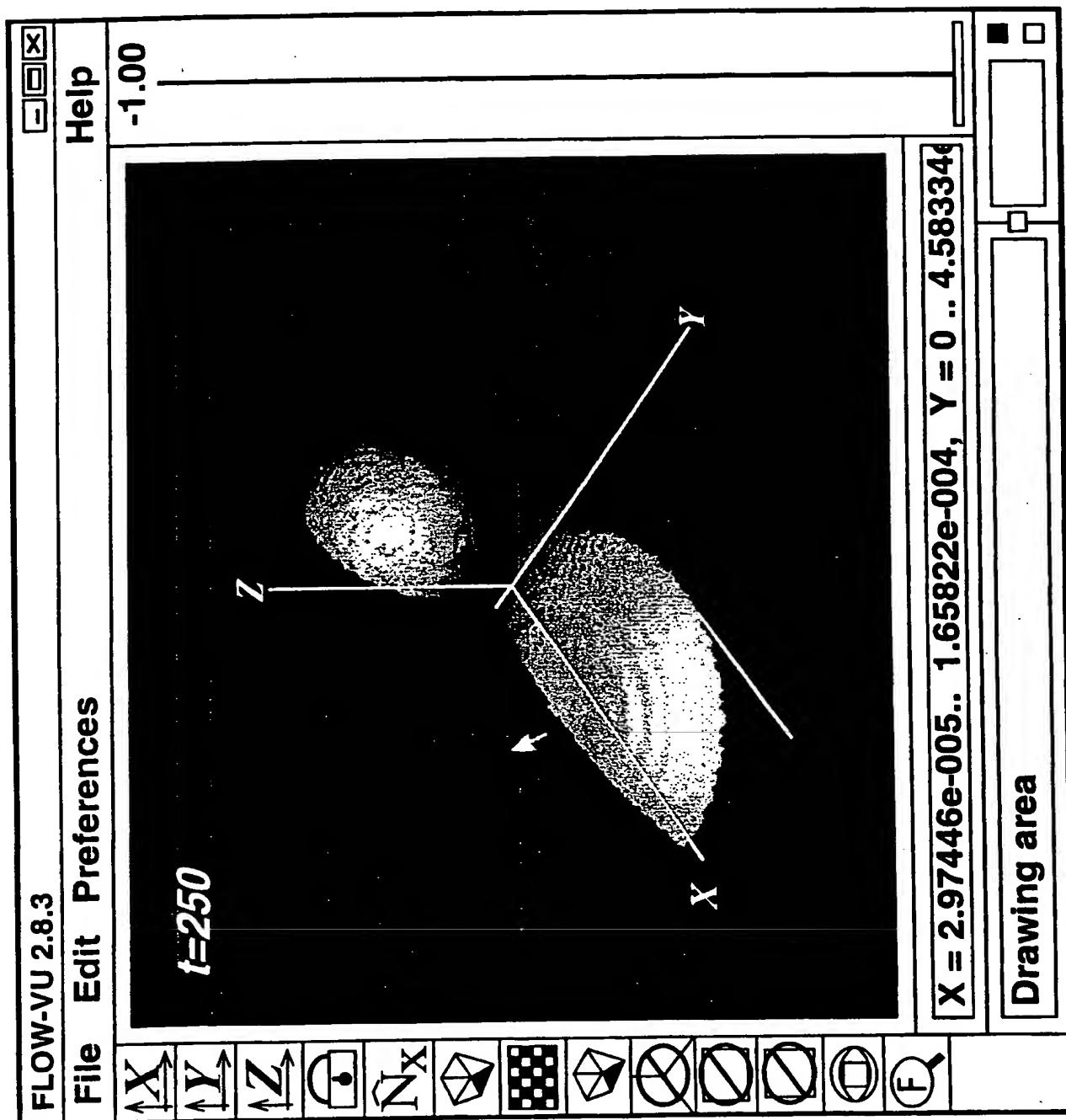


FIG. 6

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FIG. 7

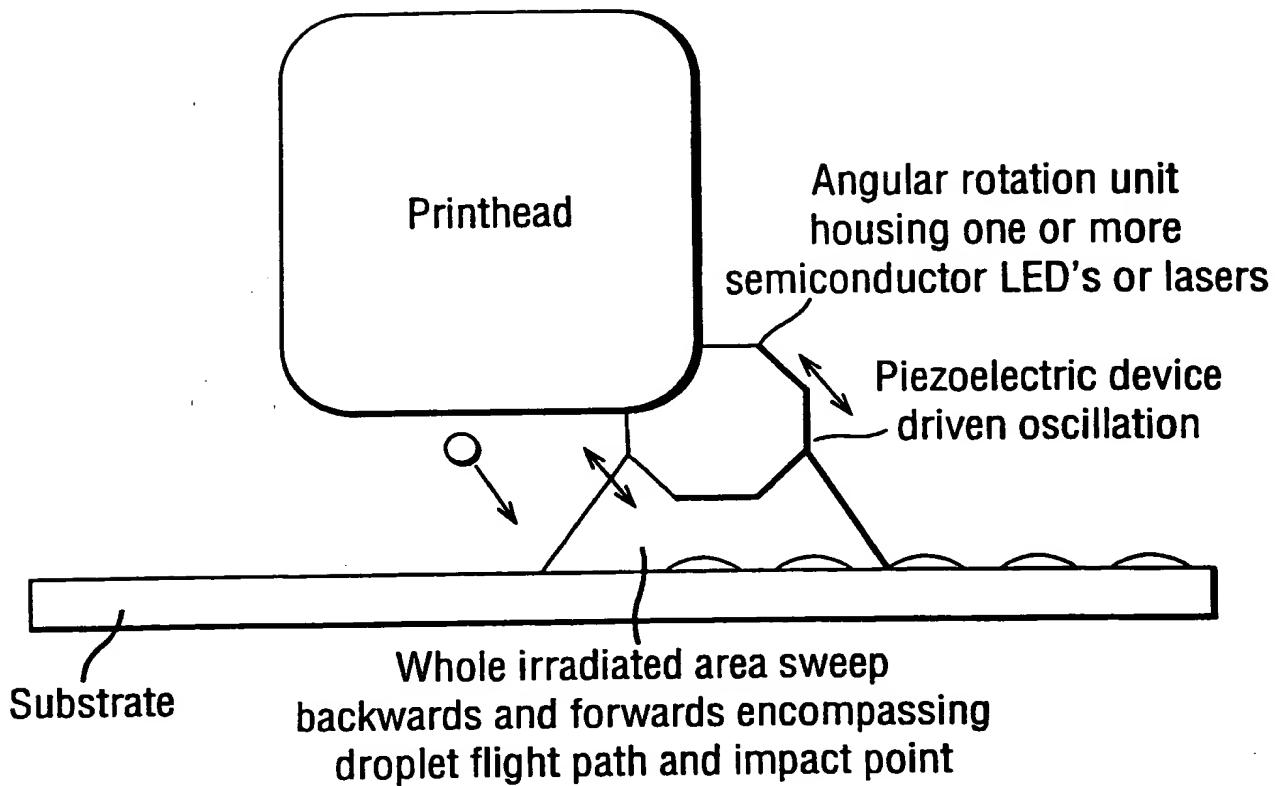


FIG. 8

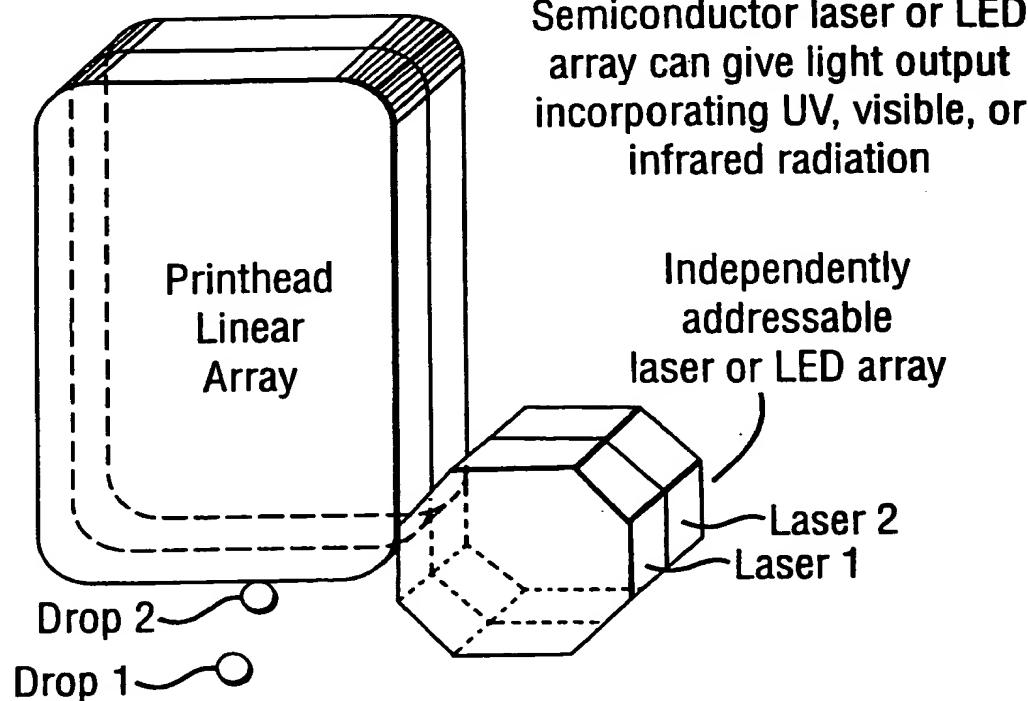


FIG. 9

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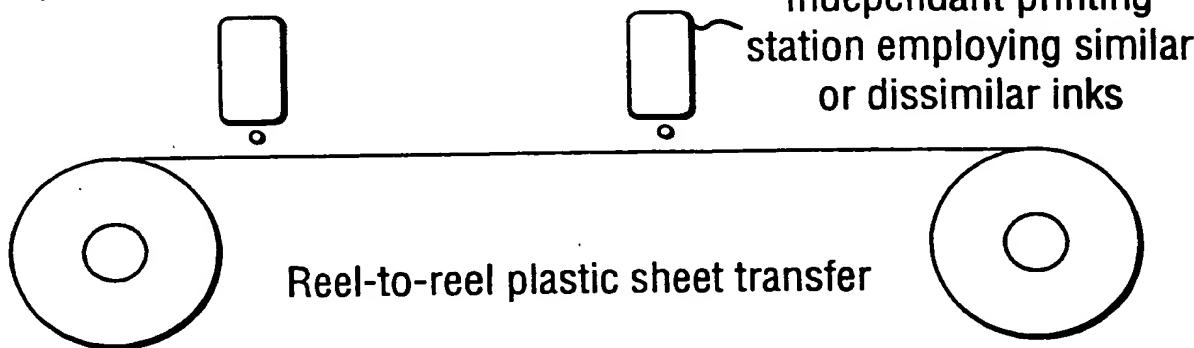


FIG. 10

Organic or inorganic thin film light-emitting device

Printhead

LEP light source can be constructed in discrete stripes, thereby providing control over irradiated area

The organic LEP curing system can be used for whole area

Radiation curing zone

Bi-directional printing capability

FIG. 11

Printhead

CCD or silicon x-y linear imaging array can be used as an alternative

Organic LEP photoconductive imaging linear array

LED array

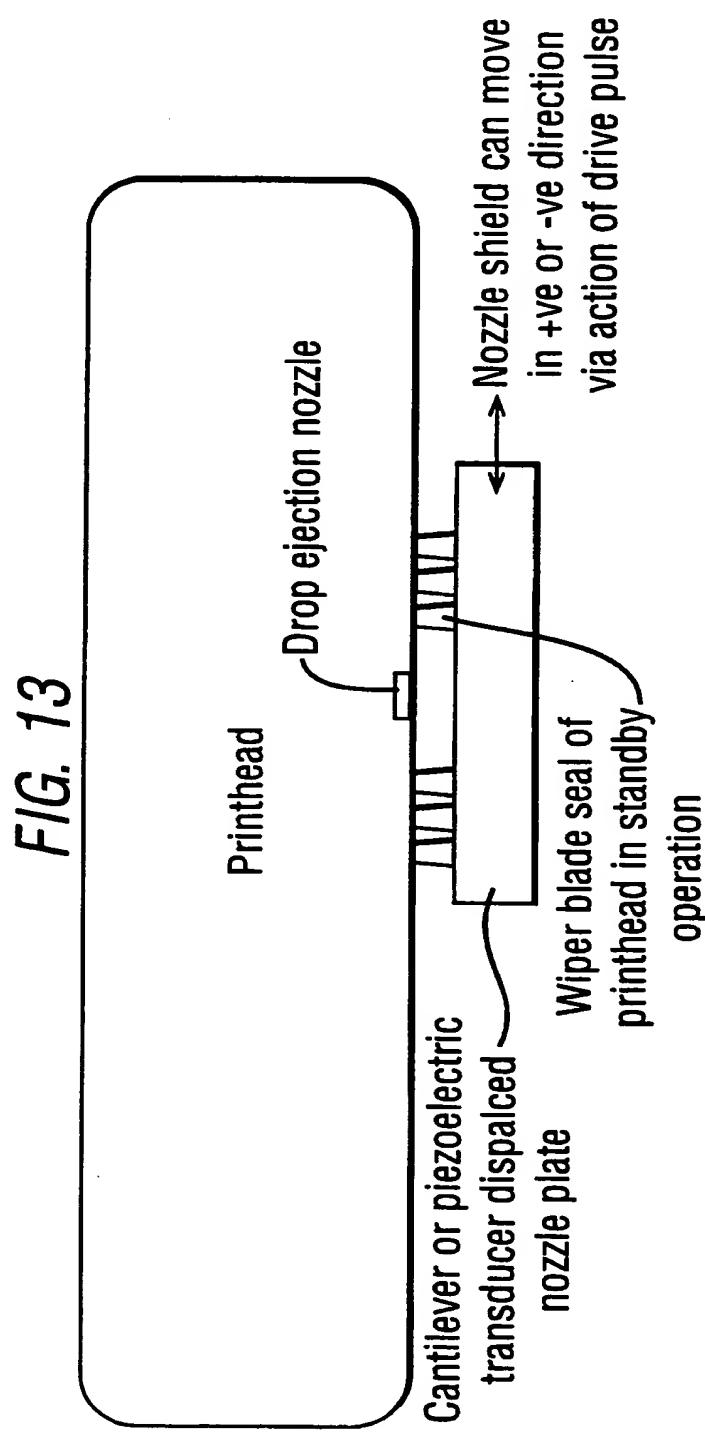
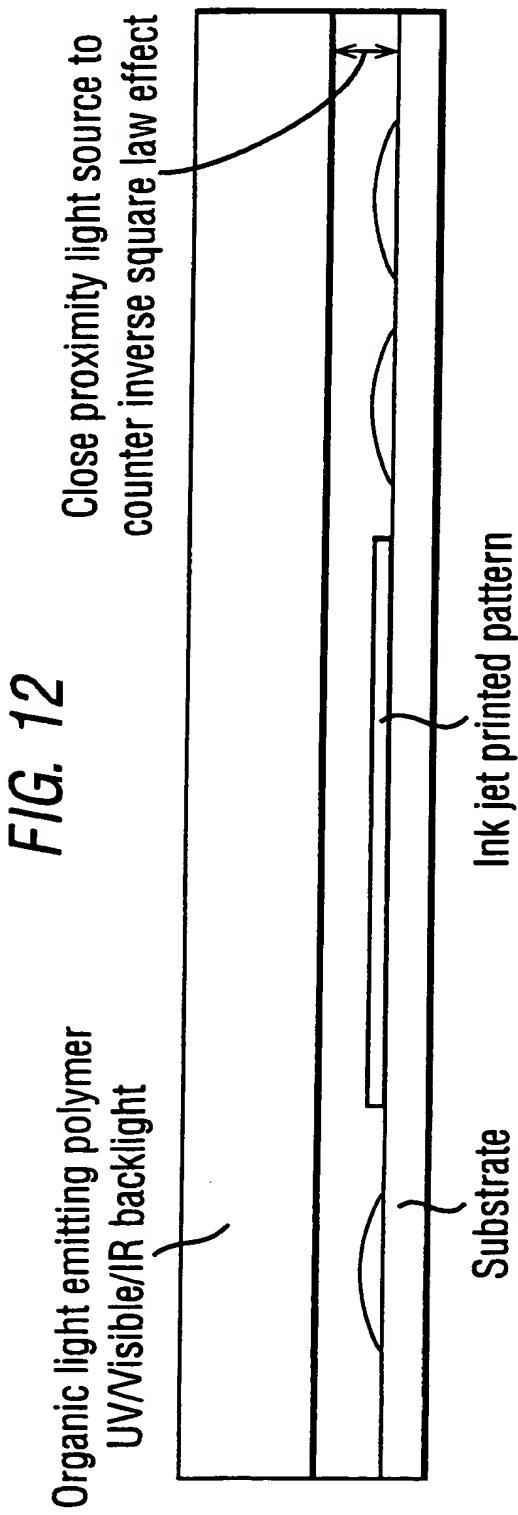
Linear Imager

Substrate

Radiation cure

Single pixel,
single dot imaging

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FIG. 14

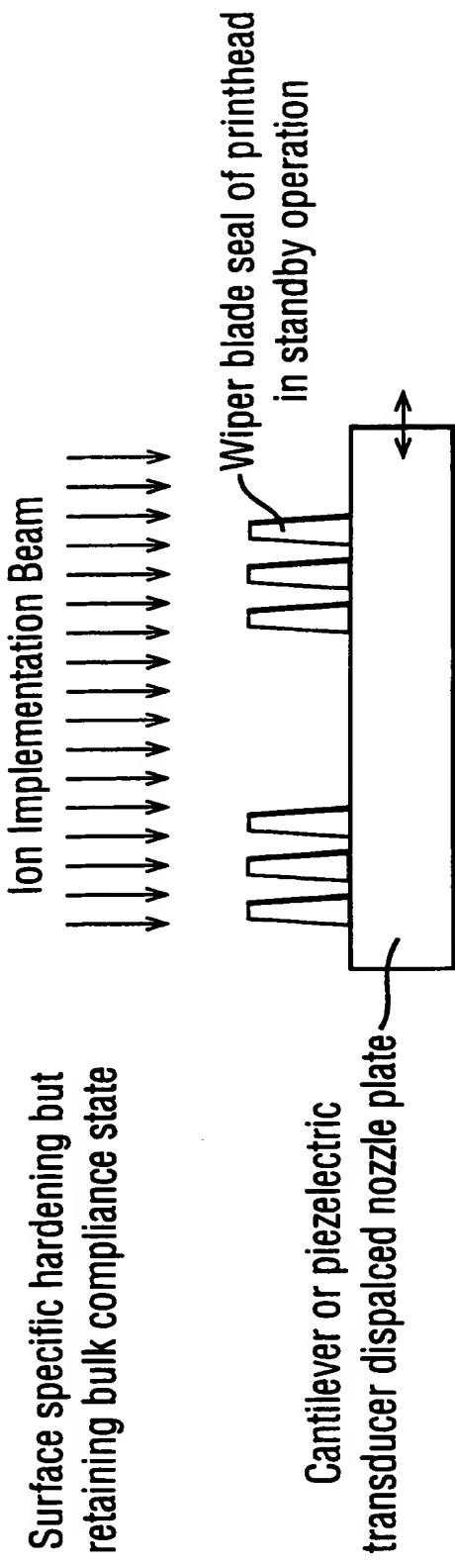
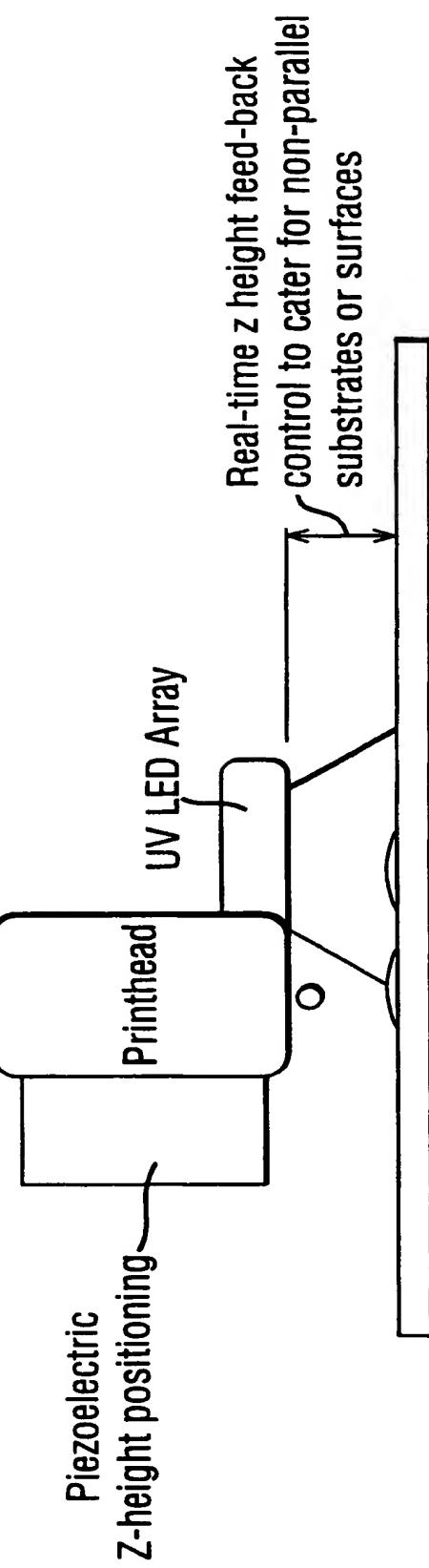
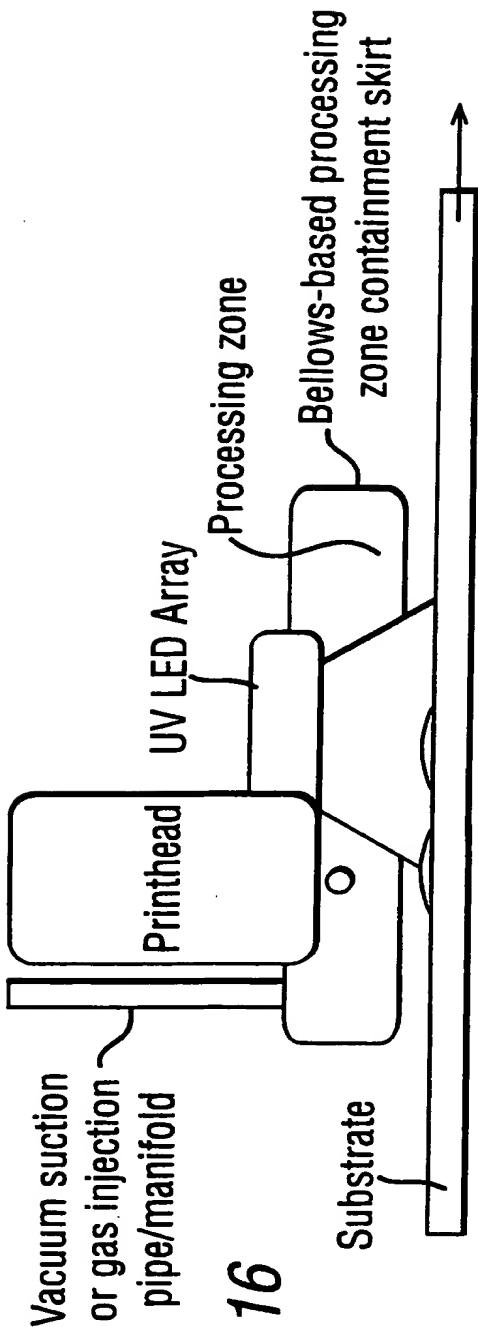


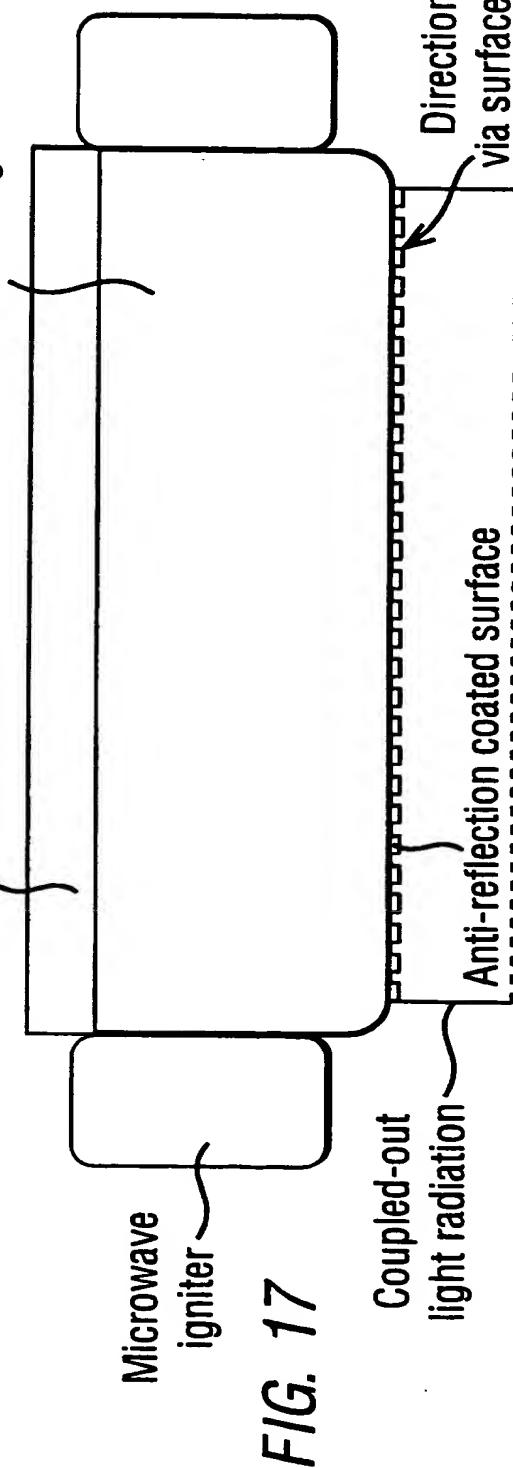
FIG. 15





Source UV LED could also include an infrared rapid thermal heating

Wavelength specific thin film reflection surface



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FIG. 18

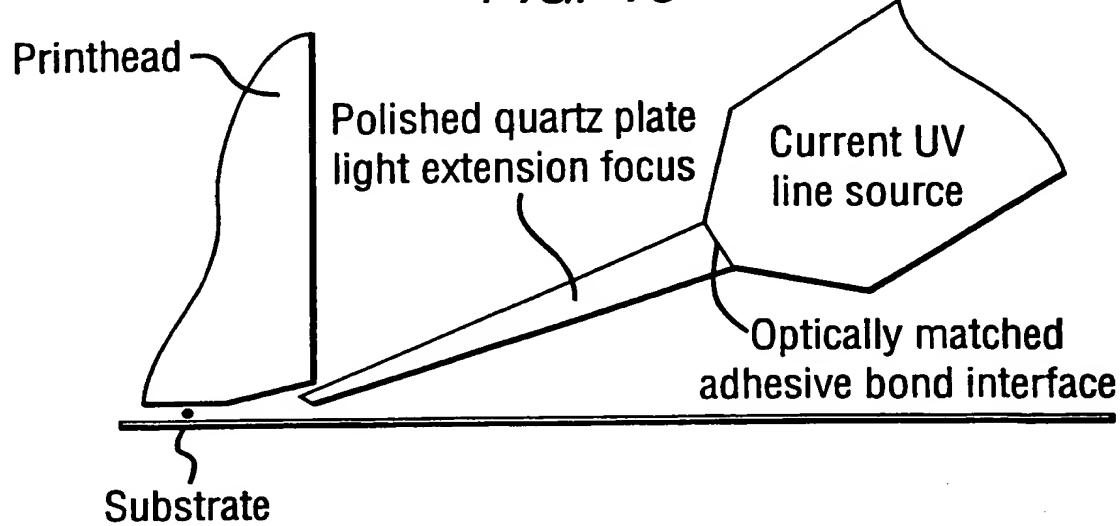


FIG. 19

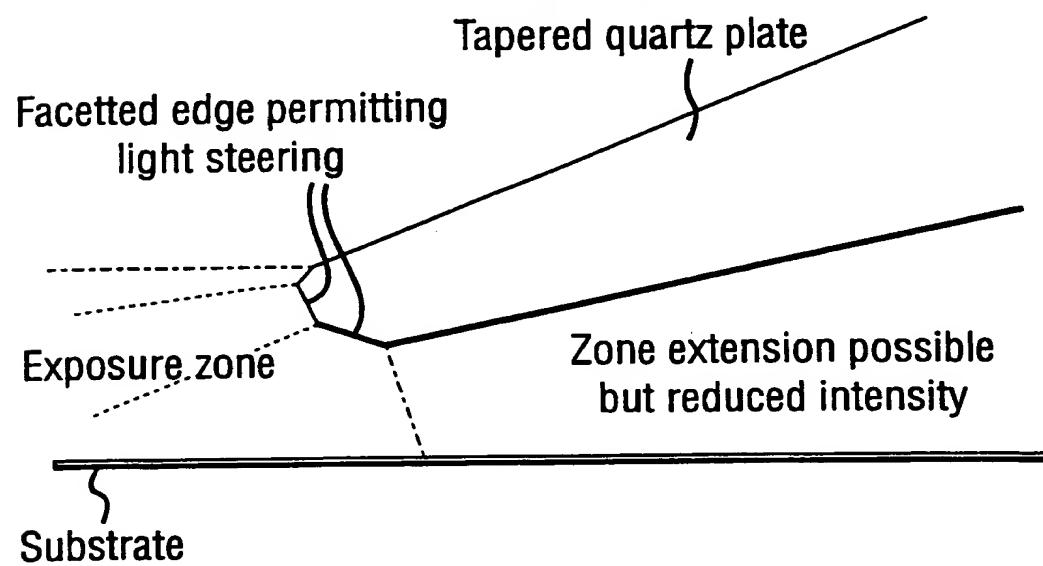
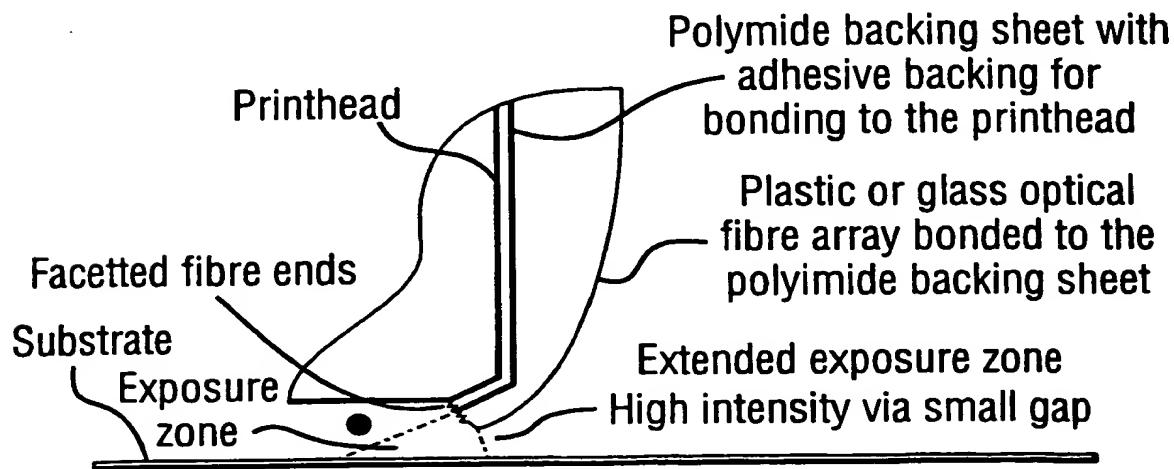


FIG. 20



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FIG. 21

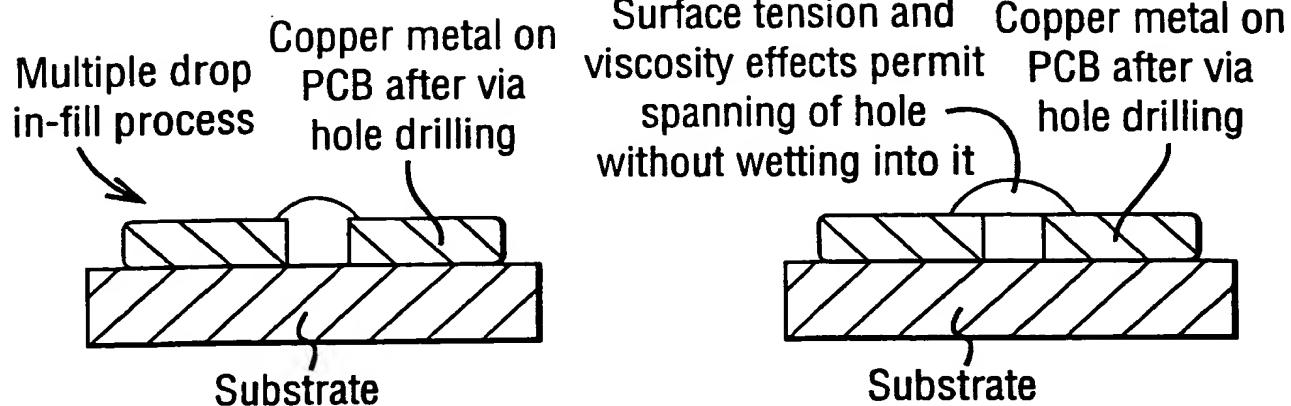


FIG. 22

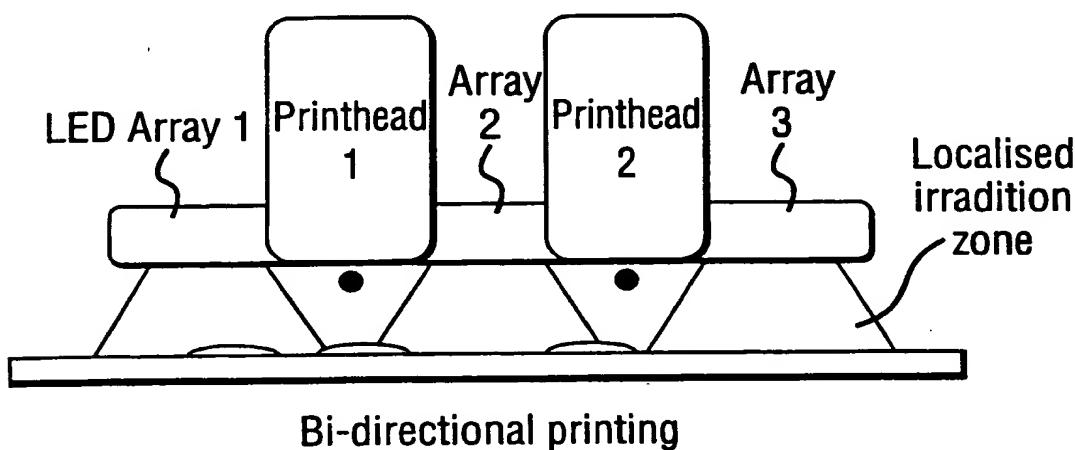
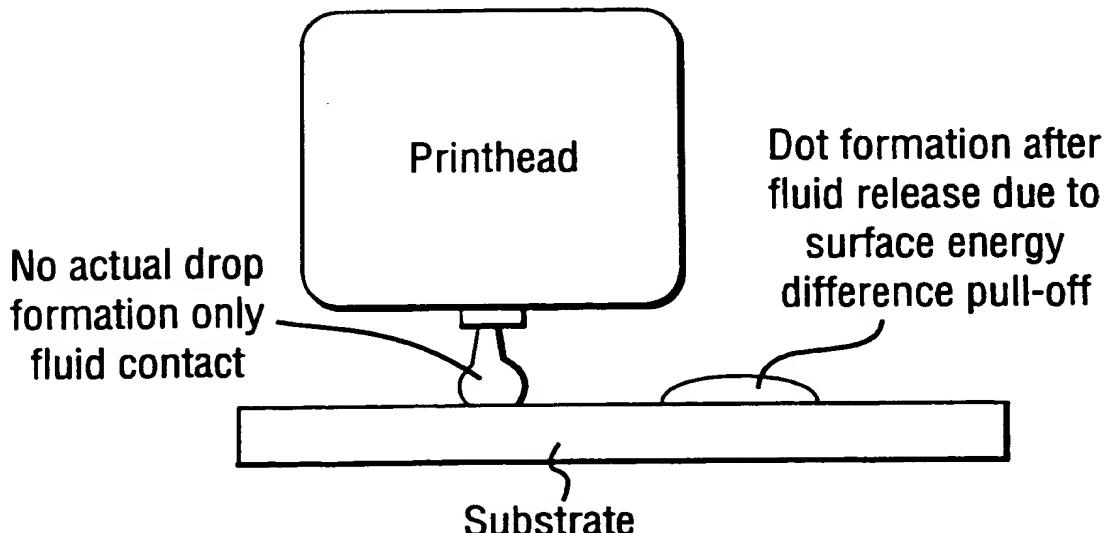


FIG. 23



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FIG. 24

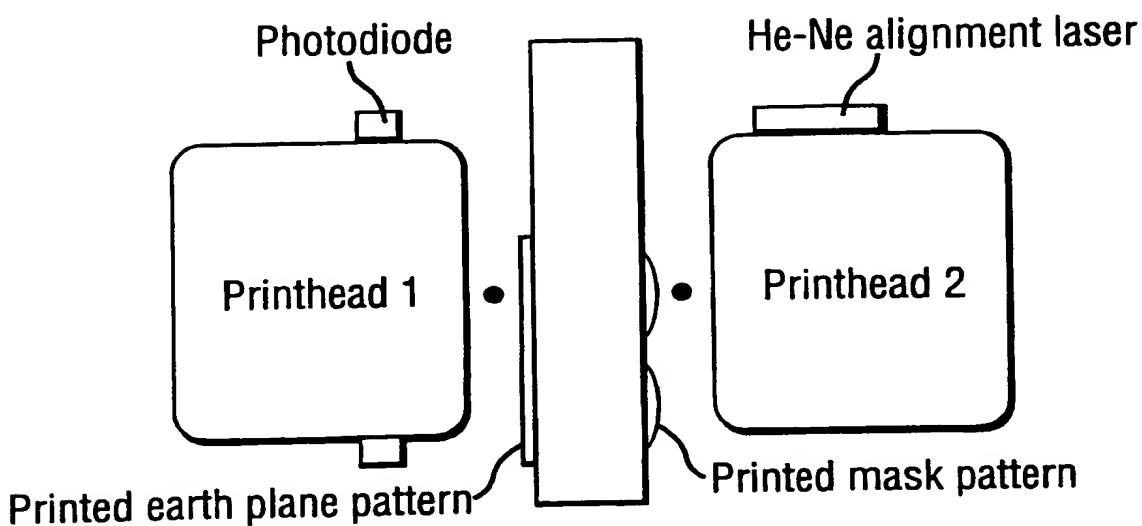


FIG. 25

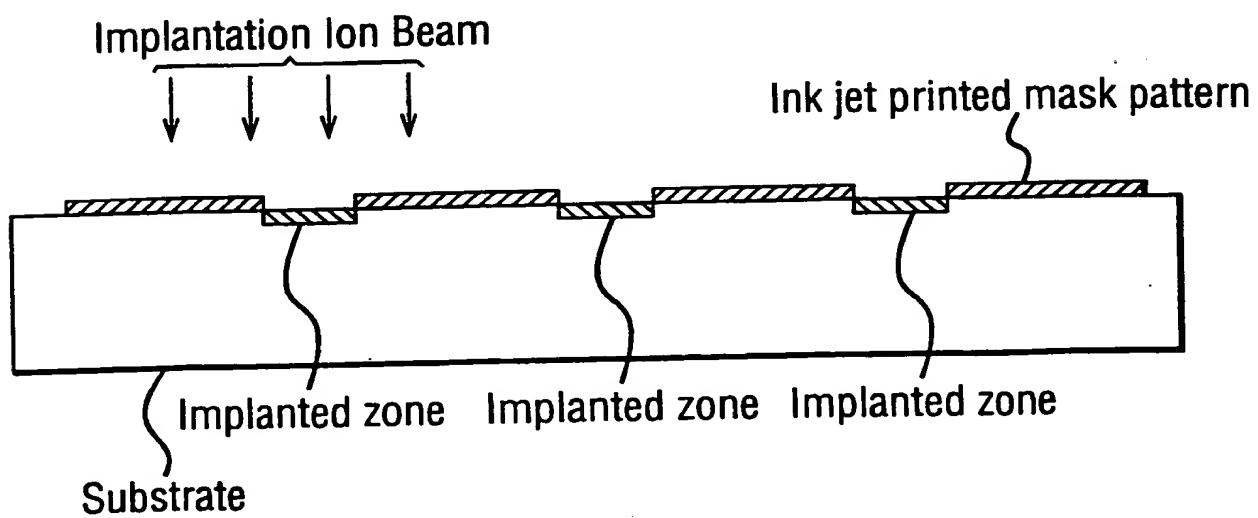


FIG. 26

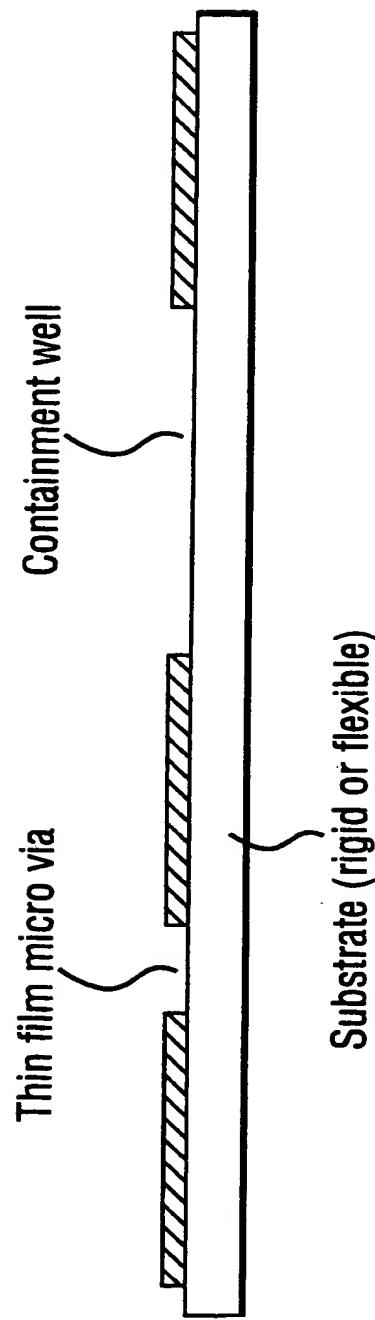


FIG. 27

Auto-alignment of two pieces
via spacer surface tension

